

**CET**

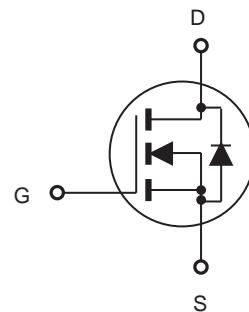
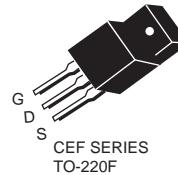
# CEP9055/CEB9055 CEF9055

## N-Channel Enhancement Mode Field Effect Transistor

### FEATURES

Type	V <sub>DSS</sub>	R <sub>DS(ON)</sub>	I <sub>D</sub>	@V <sub>GS</sub>
CEP9055	55V	10.5mΩ	100A	10V
CEB9055	55V	10.5mΩ	100A	10V
CEF9055	55V	10.5mΩ	100A <sup>e</sup>	10V

- Super high dense cell design for extremely low R<sub>DS(ON)</sub>.
- High power and current handing capability.
- Lead free product is acquired.
- TO-220 <sup>g</sup> & TO-263 package & TO-220F full-pak for through hole.



### ABSOLUTE MAXIMUM RATINGS

T<sub>C</sub> = 25°C unless otherwise noted

Parameter	Symbol	Limit		Units
		TO-220/263	TO-220F	
Drain-Source Voltage	V <sub>DS</sub>	55		V
Gate-Source Voltage	V <sub>GS</sub>	±20		V
Drain Current-Continuous	I <sub>D</sub>	100	100 <sup>e</sup>	A
Drain Current-Pulsed <sup>a</sup>	I <sub>DM</sub> <sup>f</sup>	300	300 <sup>e</sup>	A
Maximum Power Dissipation @ T <sub>C</sub> = 25°C - Derate above 25°C	P <sub>D</sub>	200 1.3	75 0.5	W W/°C
Single Pulsed Avalanche Energy <sup>d</sup>	E <sub>AS</sub>	325	325	mJ
Single Pulsed Avalanche Current <sup>d</sup>	I <sub>AS</sub>	50	50	A
Operating and Store Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to 175		°C

### Thermal Characteristics

Parameter	Symbol	Limit		Units
Thermal Resistance, Junction-to-Case	R <sub>θJC</sub>	0.75	2	°C/W
Thermal Resistance, Junction-to-Ambient	R <sub>θJA</sub>	62.5	65	°C/W



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### Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

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Parameter	Symbol	Test Condition	Min	Typ	Max	Units
<b>Off Characteristics</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$	55			V
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{\text{DS}} = 55\text{V}, V_{\text{GS}} = 0\text{V}$			10	$\mu\text{A}$
Gate Body Leakage Current, Forward	$I_{\text{GSSF}}$	$V_{\text{GS}} = 20\text{V}, V_{\text{DS}} = 0\text{V}$			100	nA
Gate Body Leakage Current, Reverse	$I_{\text{GSSR}}$	$V_{\text{GS}} = -20\text{V}, V_{\text{DS}} = 0\text{V}$			-100	nA
<b>On Characteristics<sup>b</sup></b>						
Gate Threshold Voltage	$V_{\text{GS(th)}}$	$V_{\text{GS}} = V_{\text{DS}}, I_D = 250\mu\text{A}$	2		4	V
Static Drain-Source On-Resistance	$R_{\text{DS(on)}}$	$V_{\text{GS}} = 10\text{V}, I_D = 62\text{A}$		8.8	10.5	$\text{m}\Omega$
Forward Transconductance	$g_{\text{FS}}$	$V_{\text{DS}} = 25\text{V}, I_D = 62\text{A}$		28		S
<b>Dynamic Characteristics<sup>c</sup></b>						
Input Capacitance	$C_{\text{iss}}$	$V_{\text{DS}} = 25\text{V}, V_{\text{GS}} = 0\text{V}, f = 1.0 \text{ MHz}$		2700		pF
Output Capacitance	$C_{\text{oss}}$			800		pF
Reverse Transfer Capacitance	$C_{\text{rss}}$			115		pF
<b>Switching Characteristics<sup>c</sup></b>						
Turn-On Delay Time	$t_{\text{d(on)}}$	$V_{\text{DD}} = 28\text{V}, I_D = 62\text{A}, V_{\text{GS}} = 10\text{V}, R_{\text{GEN}} = 4.5\Omega$		40	80	ns
Turn-On Rise Time	$t_r$			20	45	ns
Turn-Off Delay Time	$t_{\text{d(off)}}$			65	120	ns
Turn-On Fall Time	$t_f$			15	35	ns
Total Gate Charge	$Q_g$	$V_{\text{DS}} = 44\text{V}, I_D = 62\text{A}, V_{\text{GS}} = 10\text{V}$		60	80	nC
Gate-Source Charge	$Q_{\text{gs}}$			15		nC
Gate-Drain Charge	$Q_{\text{gd}}$			22		nC
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
Drain-Source Diode Forward Current	$I_S$				62	A
Drain-Source Diode Forward Voltage <sup>b</sup>	$V_{\text{SD}}$	$V_{\text{GS}} = 0\text{V}, I_S = 62\text{A}$			1.3	V

Notes :

a.Repetitive Rating : Pulse width limited by maximum junction temperature

b.Pulse Test : Pulse Width  $\leq 300\mu\text{s}$ . Duty Cycle  $\leq 2\%$ .

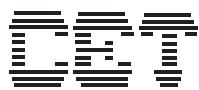
c.Guaranteed by design, not subject to production testing.

d.L =  $260\mu\text{H}$ ,  $I_S = 50\text{A}$ ,  $V_{\text{DD}} = 30\text{V}$ ,  $R_G = 25\Omega$ . Starting  $T_J = 25^\circ\text{C}$

e.Limited only by maximum temperature allowed .

f.Pulse width limited by safe operating area .

g.The mounting torque (4-40/M3 screw) in TO-220 package is recommended within 3-4Kgf-cm (MAX. 4Kgf-cm)



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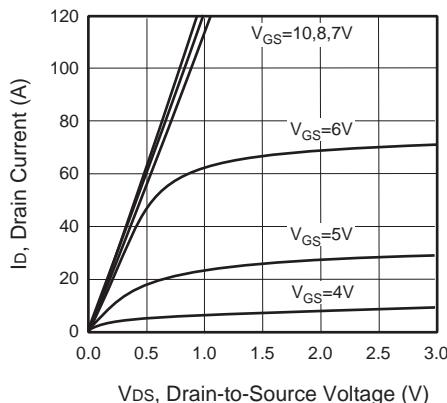


Figure 1. Output Characteristics

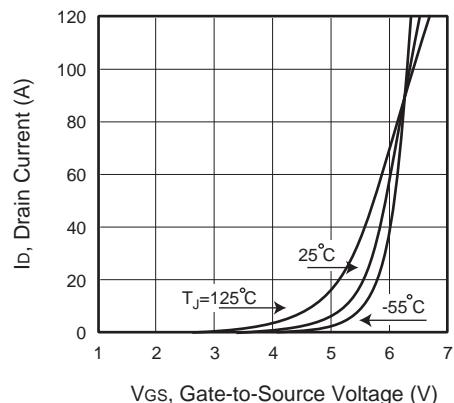


Figure 2. Transfer Characteristics

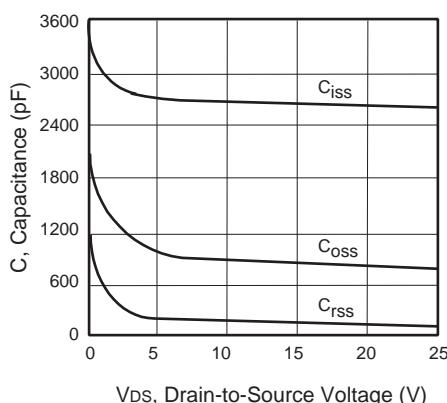


Figure 3. Capacitance

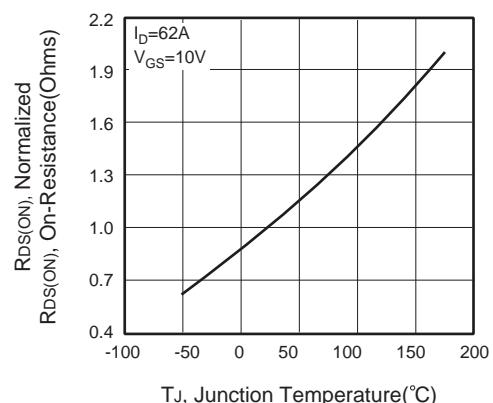


Figure 4. On-Resistance Variation with Temperature

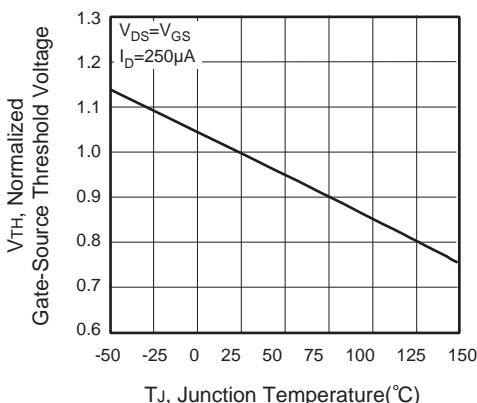


Figure 5. Gate Threshold Variation with Temperature

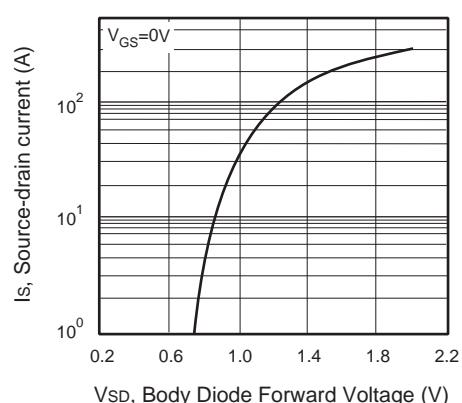


Figure 6. Body Diode Forward Voltage Variation with Source Current

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